

Product Texts

PPA flame retardant injection moulding grade, 30% glass fibre reinforced. Halogen and red phosphorus free. High melting point. Black colour.

Suitable for parts requiring fire retardancy along with high stiffness and good mechanical resistance. Suitable for Lead Free Soldering application. Rated V0 according to UL94.

Processing/Physical Characteristics	dry / cond	Unit	Test Standard
ISO Data			
^[C] Molding shrinkage, parallel	0.4 / *	%	ISO 294-4, 2577
^[C] Molding shrinkage, normal	0.9 / *	%	ISO 294-4, 2577

[C]: CAMPUS

Mechanical properties	dry / cond	Unit	Test Standard
ISO Data			
^[C] Tensile Modulus	11700 / 11500	MPa	ISO 527
^[C] Stress at break	155 / 140	MPa	ISO 527
^[C] Strain at break	2.5 / 2.5	%	ISO 527
^[C] Charpy impact strength, +23°C	55 / -	kJ/m ²	ISO 179/1eU
^[C] Charpy impact strength, -30°C	50 / -	kJ/m ²	ISO 179/1eU
^[C] Charpy notched impact strength, +23°C	9.5 / 10	kJ/m ²	ISO 179/1eA
^[C] Charpy notched impact strength, -30°C	10 / -	kJ/m ²	ISO 179/1eA

[C]: CAMPUS

Thermal properties	dry / cond	Unit	Test Standard
ISO Data			
^[C] Melting temperature, 10°C/min	305 / *	°C	ISO 11357-1/-3
^[C] Temp. of deflection under load, 1.80 MPa	280 / *	°C	ISO 75-1/-2
^[C] Burning Behav. at 1.5 mm nom. thickn.	V-0 / *	class	IEC 60695-11-10
Thickness tested	0.4 / *	mm	-
Yellow Card available	yes / *	-	-
^[C] Burning Behav. at thickness h	V-0 / *	class	IEC 60695-11-10
Thickness tested	1.5 / *	mm	-
Yellow Card available	yes / *	-	-
^[C] Burning Behav. 5V at thickness h	5VA / *	class	IEC 60695-11-20
Thickness tested	1.5 / *	mm	-
Yellow Card available	yes / *	-	-

[C]: CAMPUS

Electrical properties	dry / cond	Unit	Test Standard
ISO Data			
^[C] Volume resistivity	1E13 / -	Ohm*m	IEC 62631-3-1
^[C] Comparative tracking index	550 / -	-	IEC 60112

[C]: CAMPUS

Other properties	dry / cond	Unit	Test Standard
^[C] Humidity absorption	1.3 / *	%	Sim. to ISO 62
^[C] Density	1470 / -	kg/m ³	ISO 1183

[C]: CAMPUS

Characteristics

Processing

Injection Molding

Special Characteristics

Flame retardant, Halogen-free, Phosphorus-free, Heat stabilized or stable to heat

Delivery form

Granules, Black

Regional Availability

North America, Europe, Asia Pacific, South and Central America, Near East/Africa

Additives

Release agent

Other text information**Injection molding**

The material is delivered in moisture-proof packaging ready for processing. Maximum recommended water content for best processing is 0.10%. Typical conditions with a desiccant drier: temperature 120° C, dew point -20 ° C or below, time 4 h or more. Avoid excessive shear rates and high thermal stresses for better processing. Special care must be taken to avoid moisture absorption and contamination with other polymers when adding regrind material. Colour variation and mechanical properties reduction may occur and should always be carefully monitored.

Injection Molding Processing Parameters

Melt Temperature

310 - 320°C

Mold Temperature

110 - 130°C

Injection Speed

medium